



40V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _C = +25°C
40V	24mΩ @V _{GS} = 10V	28A
40 V	32mΩ @V _{GS} = 4.5V	24A

Description

This MOSFET is designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Backlighting
- DC-DC Converters
- · Power Management Functions

Features

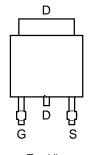
- 100% Unclamped Inductive Switch (UIS) Test in Production
- Low On-resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

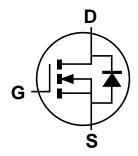
- Case: TO252
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.33 grams (Approximate)







Top View Pin-Out



Equivalent Circuit

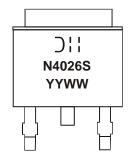
Ordering Information (Note 4)

Product	Case	Packaging
DMN4026SK3-13	TO252	2,500/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



);; = Manufacturer's Marking
N4026S = Product Type Marking Code
YYWW = Date Code Marking
YY = Year (ex: 15 = 2015)
WW = Week (01 to 53)



Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	40	V
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 6) V _{GS} = 10V	ΙD	28 18	А		
Maximum Body Diode Continuous Current	Is	2.5	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	I _{DM}	70	Α		
Avalanche Current (Note 7) L = 0.1mH			I _{AS}	18	Α
Avalanche Energy (Note 7) L = 0.1mH	Eas	17	mJ		

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

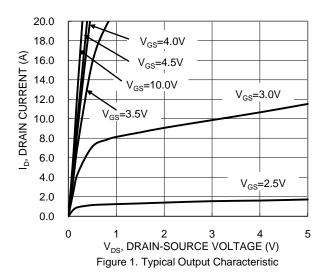
Characteristic	Symbol	Value	Unit		
Total Dawar Dissination (Note 5)	T _A = +25°C		1.6	W	
Total Power Dissipation (Note 5)	$T_A = +70^{\circ}C$	P_{D}	1.0		
Thermal Resistance, Junction to Ambient (Note 5)	Steady state	D	75	°C/W	
Thermal Resistance, Junction to Ambient (Note 3)	t<10s	$R_{\theta JA}$	32.7	C/VV	
Total Power Dissipation (Note 6)	$T_A = +25$ °C	В	3.4	W	
Total Power Dissipation (Note 6)	$T_A = +70^{\circ}C$	P_{D}	2.1		
Thermal Resistance, Junction to Ambient (Note 6)	Steady state	D	37	°C/W	
Thermal Resistance, Junction to Ambient (Note o)	t<10s	$R_{\theta JA}$	18.1		
Thermal Resistance, Junction to Case (Note 6)	$R_{ heta JC}$	4.5			
Operating and Storage Temperature Range		$T_{J_i} T_{STG}$	-55 to +150	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	40		_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	_		1	μΑ	$V_{DS} = 40V, V_{GS} = 0V$	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(TH)}	1		3	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	D	_	15	24	mΩ	$V_{GS} = 10V, I_D = 6A$	
Static Dialii-Source Oil-Resistance	R _{DS(ON)}	_	20	32	11177	$V_{GS} = 4.5V, I_D = 5A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1.0A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	_	1181	_		$V_{DS} = 20V, V_{GS} = 0V,$ f = 1.0MHz	
Output Capacitance	Coss	_	85	_	pF		
Reverse Transfer Capacitance	Crss	_	63	_			
Gate Resistance	R _G	_	1.5	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	9.6	_			
Total Gate Charge (V _{GS} = 10V)	Qg	_	21.3	_	nC	V 20V I 0A	
Gate-Source Charge	Q_{gs}	_	3.7	_	110	$V_{DS} = 20V, I_{D} = 8A$	
Gate-Drain Charge	Q_{gd}	_	3.0	_			
Turn-On Delay Time	t _{D(ON)}	_	4.3	_		$V_{DD} = 25V, R_L = 2.5\Omega$ $V_{GS} = 10V, R_G = 3\Omega$	
Turn-On Rise Time	t _R	_	4.6	_			
Turn-Off Delay Time	t _{D(OFF)}	_	19.5	_	ns		
Turn-Off Fall Time	t _F	_	3.1	_			
Body Diode Reverse Recovery Time	t _{RR}	_	12.0	_	ns	I _F = 8A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	3.85	_	nC	I _F = 8A, di/dt = 100A/µs	

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
- I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.





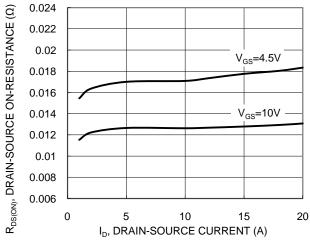


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

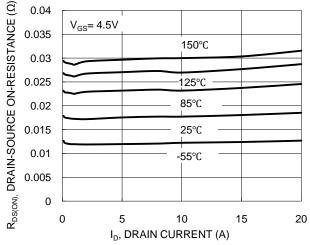
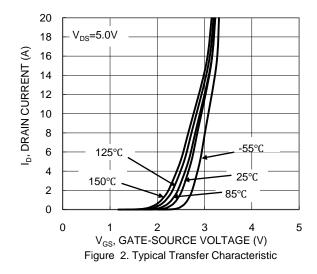
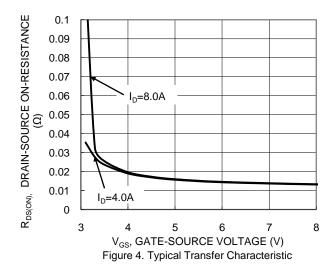


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





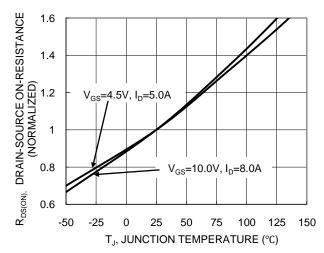


Figure 6. On-Resistance Variation with Temperature



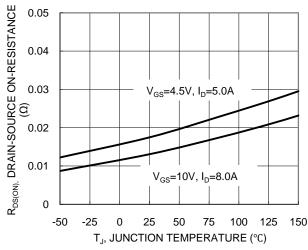
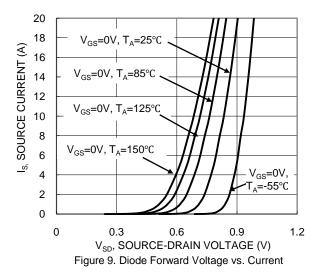
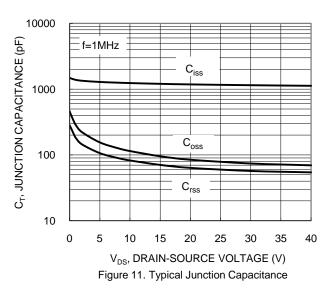


Figure 7. On-Resistance Variation with Temperature





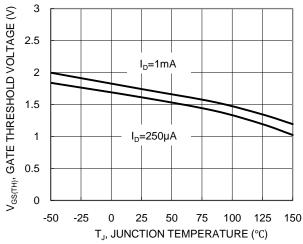


Figure 8. Gate Threshold Variation vs. Junction Temperature

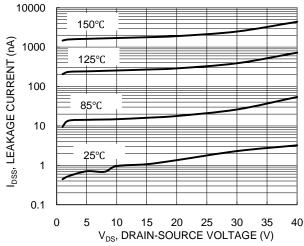
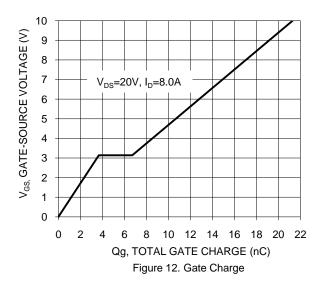


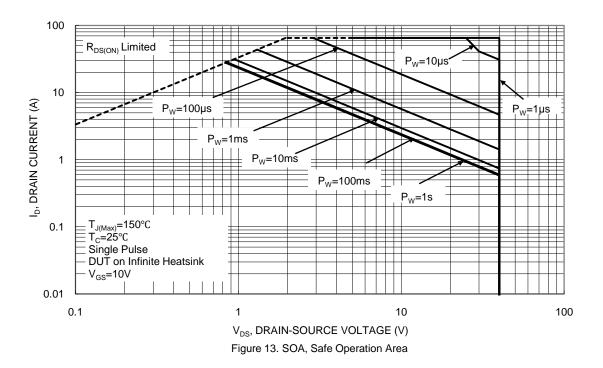
Figure 10. Typical Drain-Source Leakage Current vs. Voltage

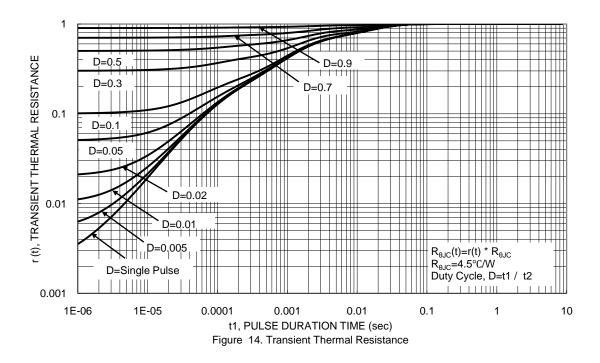


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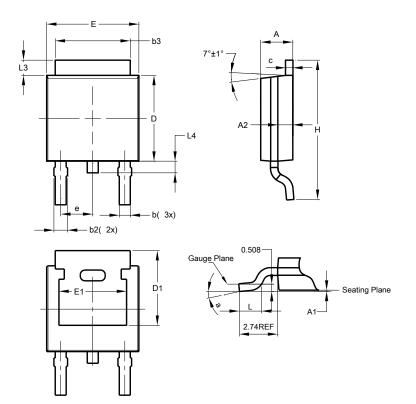






Package Outline Dimensions

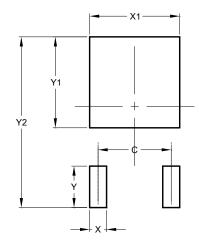
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



TO252 (DPAK)					
Dim	Min	Max	Тур		
Α	2.19	2.39	2.29		
A1	0.00	0.13	0.08		
A2	0.97	1.17	1.07		
b	0.64	0.88	0.783		
b2	0.76	1.14	0.95		
b3	5.21	5.46	5.33		
С	0.45	0.58	0.531		
D	6.00	6.20	6.10		
D1	5.21	-	-		
е	-	-	2.286		
Е	6.45	6.70	6.58		
E1	4.32	-	-		
Н	9.40	10.41	9.91		
L	1.40	1.78	1.59		
L3	0.88	1.27	1.08		
L4	0.64	1.02	0.83		
а	0°	10°	-		
All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)		
С	4.572		
Х	1.060		
X1	5.632		
Y	2.600		
Y1	5.700		
Y2	10.700		



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